

Electronic Patent Application Fee Transmittal

Application Number:	10757276			
Filing Date:	14-Jan-2004			
Title of Invention:	Semiconductor assemblies, methods of forming structures over semiconductor substrates, and methods of forming transistors associated with semiconductor substrates			
First Named Inventor/Applicant Name:	Kevin L. Beaman			
Filer:	Donald B. Kenady/Julie Foster			
Attorney Docket Number:	MI22-2475			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	1	50	50
Independent claims in excess of 3	1201	2	200	400
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Extension - 1 month with \$0 paid	1251	1	120	120
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				1360